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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
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Takashi UDAGAWA	02/18/2008

### **RECEIVING PARTY DATA**

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### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12063002

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: Q89672 **PATENT** 

500482864 REEL: 020623 FRAME: 0497

NAME OF SUBMITTER:	Abraham J. Rosner
Total Attachments: 1 source=Q89672ASSIGNMENT#page1.tif	

PATENT REEL: 020623 FRAME: 0498

# ASSIGNMENT

Whereas, I/we

- 1. OHACHI Tadashi of c/o DOSHISHA UNIVERSITY 1-3 Tatara Miyakodani, Kyotanabe-shi, Kyoto 610-0394, JAPAN
- 2. UDAGAWA Takashi of c/o SHOWA DENKO K.K., 1505 Shimokagemori, Chichibu-shi, Saitama 369-1871, JAPAN hereinafter called assignor(s), have invented certain improvements in

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME and executed an application for Letters Patent of the United States of America therefor on

> February 18 and 19, 2008; and

Whereas,

- 1. SHOWA DENKO K.K. of 13-9, Shiba Daimon 1-chome, Minato-ku, Tokyo 105-8518, JAPAN
- 2. THE DOSHISHA of 601 Genbu-cho, Karasuma-higashi-iru, Imadegawa-dori, Kamigyo-ku, Kyoto-shi, Kyoto 602-8580, JAPAN

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. § 119, and I/we request the Director - U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

I/We hereby authorize and request my/our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3213 to insert here in parentheses 12/063,002 (Application number\_\_\_ \_\_\_\_\_, filed\_\_\_February 5, 2008\_\_\_\_) the filing date and application number of said application when known.

Date: February 19, 2008

S/ Dadashi Chacki

OHACHI Tadashi

Date: February 18, 2008

S/ Dakashi Udagawa

LIDAGAWA Takashi

**RECORDED: 03/10/2008** 

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

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